BFP740F

SiGe:C NPN RF bipolar transistor

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Product description

The BFP740F is a wideband NPN RF heterojunction bipolar transistor (HBT).



Feature list

- Low noise figure NF_{min} = 1 dB at 5.5 GHz, 3 V, 6 mA
- High gain G_{ms} = 21 dB at 5.5 GHz, 3 V, 15 mA
- OIP_3 = 24 dBm at 5.5 GHz, 3 V, 15 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Wireless communications: WLAN, WiMax and UWB
- Satellite communication systems: GNSS navigation systems (GPS, GLONASS, BeiDou, Galileo), satellite radio (SDARs, DAB) and C-band LNB
- Multimedia applications such as portable TV, CATV and FM radio
- ISM applications like RKE, AMR and Zigbee, as well as for emerging wireless applications

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration				Marking	Pieces / Reel
BFP740F / BFP740FH6327XTSA1	TSFP-4-1	1 = B	2 = E	3 = C	4 = E	R7s	3000

***Attention*: ESD (Electrostatic discharge) sensitive device, observe handling precautions**

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1 Absolute maximum ratings

Table 2 Absolute maximum ratings T_A = 25 °C (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	–	4.0	V	Open base
			3.5		T_A = -55 °C, open base
Collector emitter voltage	V_{CES}		13		E-B short circuited
Collector base voltage	V_{CBO}		13		Open emitter
Emitter base voltage	V_{EBO}		1.2		Open collector
Base current	I_B		4	mA	–
Collector current	I_C		45		
Total power dissipation [1)]	P_{tot}		160	mW	$T_S \leq$ 102 °C
Junction temperature	T_J		150	°C	–
Storage temperature	T_{Stg}	-55			

Attention**: **Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

1 T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	–	300	–	K/W	–

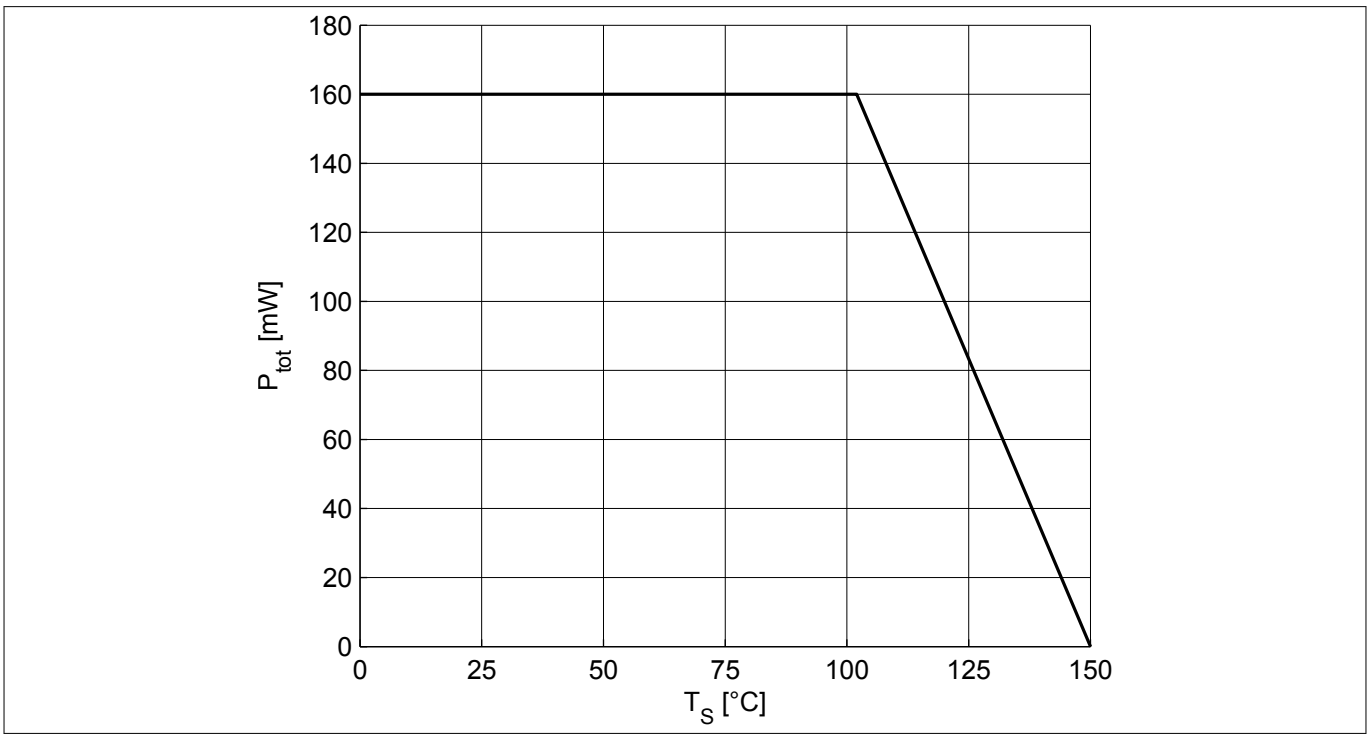


Figure 1 Total power dissipation $P_{tot} = f(T_S)$

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at T_A = 25 °C

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	4.0	4.7	–	V	I_C = 1 mA, I_B = 0, open base
Collector emitter leakage current	I_{CES}	–	1 1	400 [1)] 40 [1)]	nA	V_{CE} = 13 V, V_{BE} = 0 V_{CE} = 5 V, V_{BE} = 0, E-B short circuited
Collector base leakage current	I_{CBO}		1	40 [1)]		V_{CB} = 5 V, I_E = 0, open emitter
Emitter base leakage current	I_{EBO}		1	40 [1)]		V_{EB} = 0.5 V, I_C = 0, open collector
DC current gain	h_{FE}	160	250	400	–	V_{CE} = 3 V, I_C = 25 mA, pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at T_A = 25 °C

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Transition frequency	f_T	–	45	–	GHz	V_{CE} = 3 V, I_C = 25 mA, f = 2 GHz
Collector base capacitance	C_{CB}		0.08	0.12	pF	V_{CB} = 3 V, V_{BE} = 0, f = 1 MHz, emitter grounded
Collector emitter capacitance	C_{CE}		0.3	–		V_{CE} = 3 V, V_{BE} = 0, f = 1 MHz, base grounded
Emitter base capacitance	C_{EB}		0.4			V_{EB} = 0.5 V, V_{CB} = 0, f = 1 MHz, collector grounded

1 Maximum values not limited by the device but by the short cycle time of the 100% test

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, T_A = 25 °C.

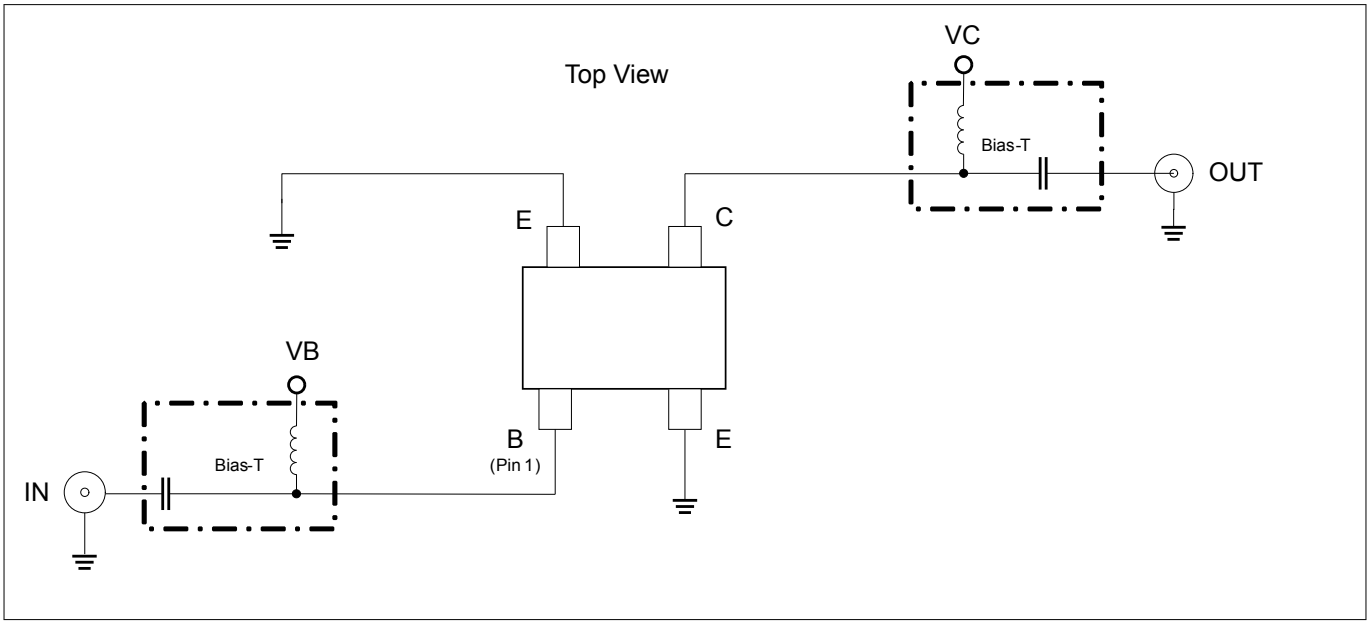


Figure 2

Table 6 AC characteristics, V_{CE} = 3 V, f = 450 MHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		32			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		30			
Noise figure						
• Minimum noise figure	NF_{min}		0.4			I_C = 6 mA
• Associated gain	G_{ass}		26.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22.5			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		6.5			

Electrical characteristics

Table 7 AC characteristics, V_{CE} = 3 V, f = 900 MHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		29			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		28			
Noise figure						
• Minimum noise figure	NF_{min}		0.45			I_C = 6 mA
• Associated gain	G_{ass}		25			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		23			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Table 8 AC characteristics, V_{CE} = 3 V, f = 1.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		26.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		25.5			
Noise figure						
• Minimum noise figure	NF_{min}		0.5			I_C = 6 mA
• Associated gain	G_{ass}		23			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22.5			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Table 9 AC characteristics, V_{CE} = 3 V, f = 1.9 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		25.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		24			
Noise figure						
• Minimum noise figure	NF_{min}		0.55			I_C = 6 mA
• Associated gain	G_{ass}		21.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		23.5			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Electrical characteristics

Table 10 AC characteristics, V_{CE} = 3 V, f = 2.4 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		24.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		22			
Noise figure						
• Minimum noise figure	NF_{min}		0.6			I_C = 6 mA
• Associated gain	G_{ass}		20			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		24			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Table 11 AC characteristics, V_{CE} = 3 V, f = 3.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		23			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		19			
Noise figure						
• Minimum noise figure	NF_{min}		0.75			I_C = 6 mA
• Associated gain	G_{ass}		17.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		24.5			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Table 12 AC characteristics, V_{CE} = 3 V, f = 5.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		21			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		15.5			
Noise figure						
• Minimum noise figure	NF_{min}		0.8			I_C = 6 mA
• Associated gain	G_{ass}		14			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		24			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Electrical characteristics

Table 13 AC characteristics, V_{CE} = 3 V, f = 10 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		14			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		9			
Noise figure						
• Minimum noise figure	NF_{min}		1.5			I_C = 6 mA
• Associated gain	G_{ass}		10			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		23.5			$Z_S = Z_L$ = 50 Ω, I_C = 15 mA
• 1 dB gain compression point at output	OP_{1dB}		8			

Note: $G_{ms} = |S_{21} / S_{12}|$ for $k < 1$; $G_{ma} = |S_{21} / S_{12}| (k-(k^2-1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz.

3.4 Characteristic DC diagrams

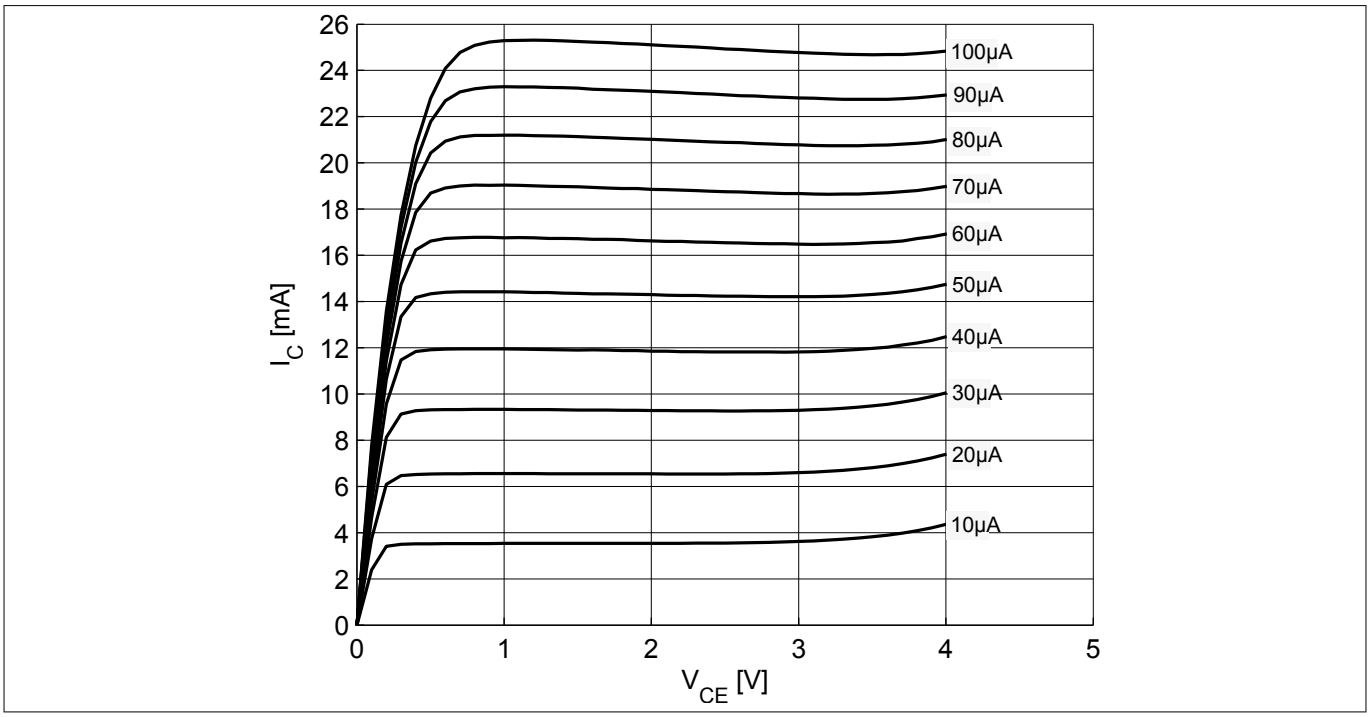


Figure 3 **Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, I_B = parameter**

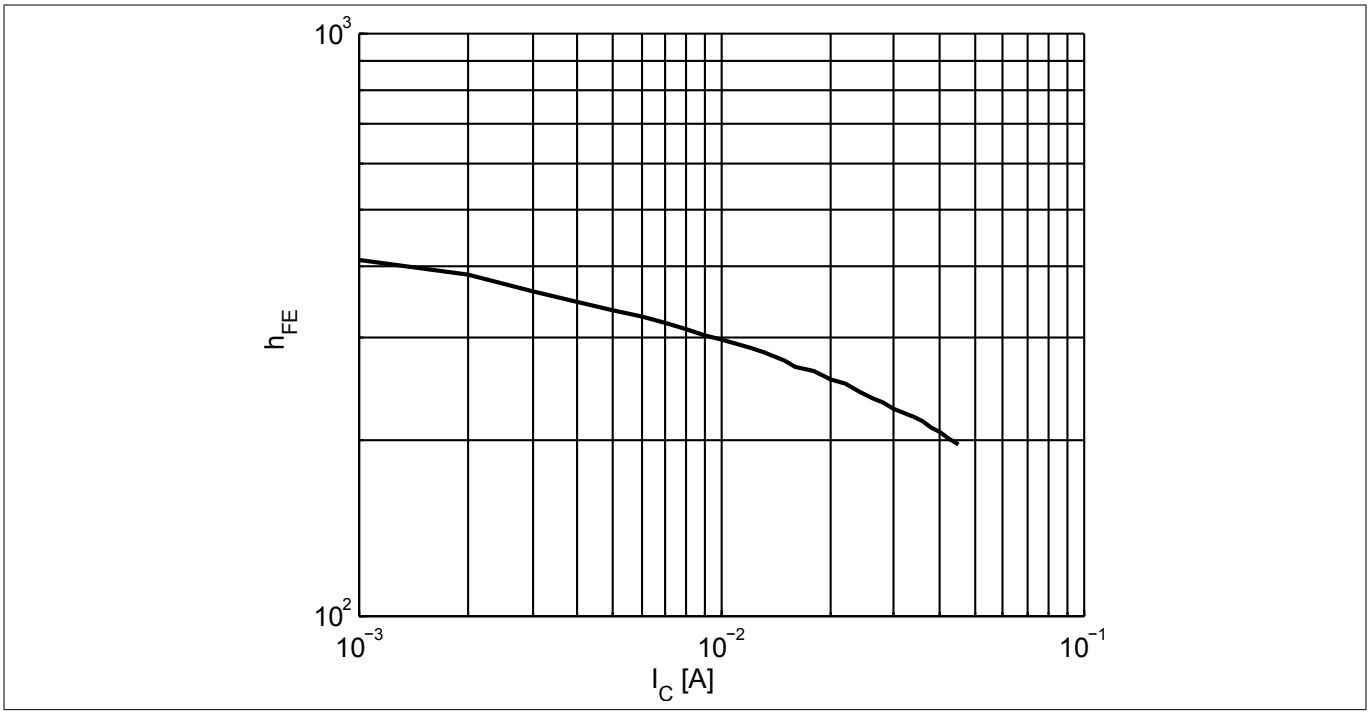


Figure 4 **DC current gain $h_{FE} = f(I_C)$, V_{CE} = 3 V**

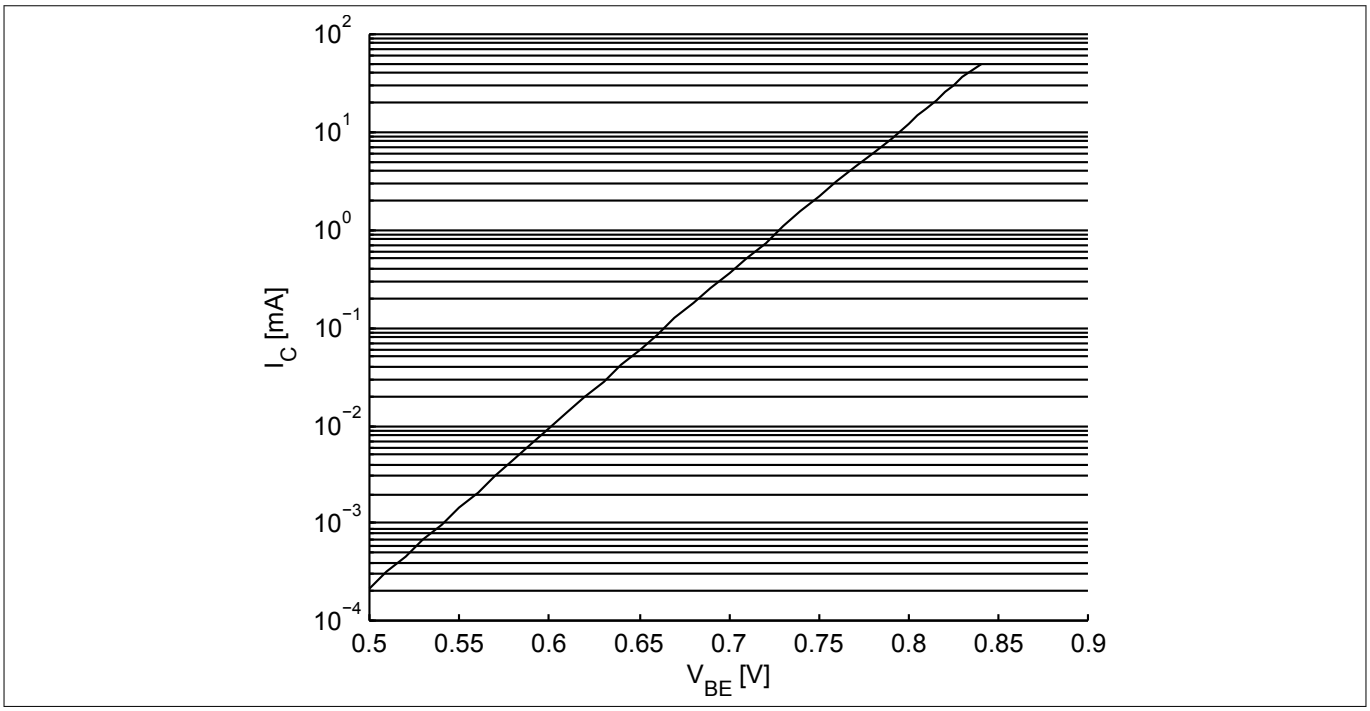


Figure 5 **Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 2$ V**

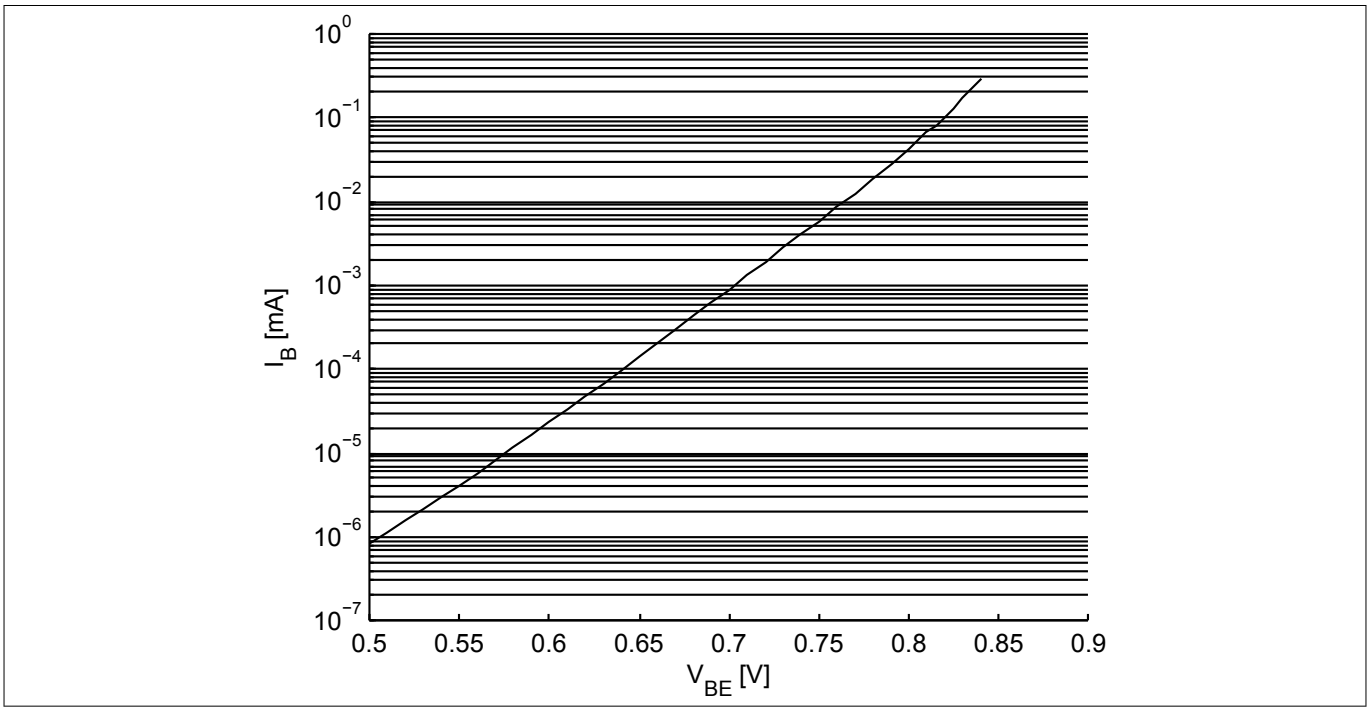


Figure 6 **Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 2$ V**

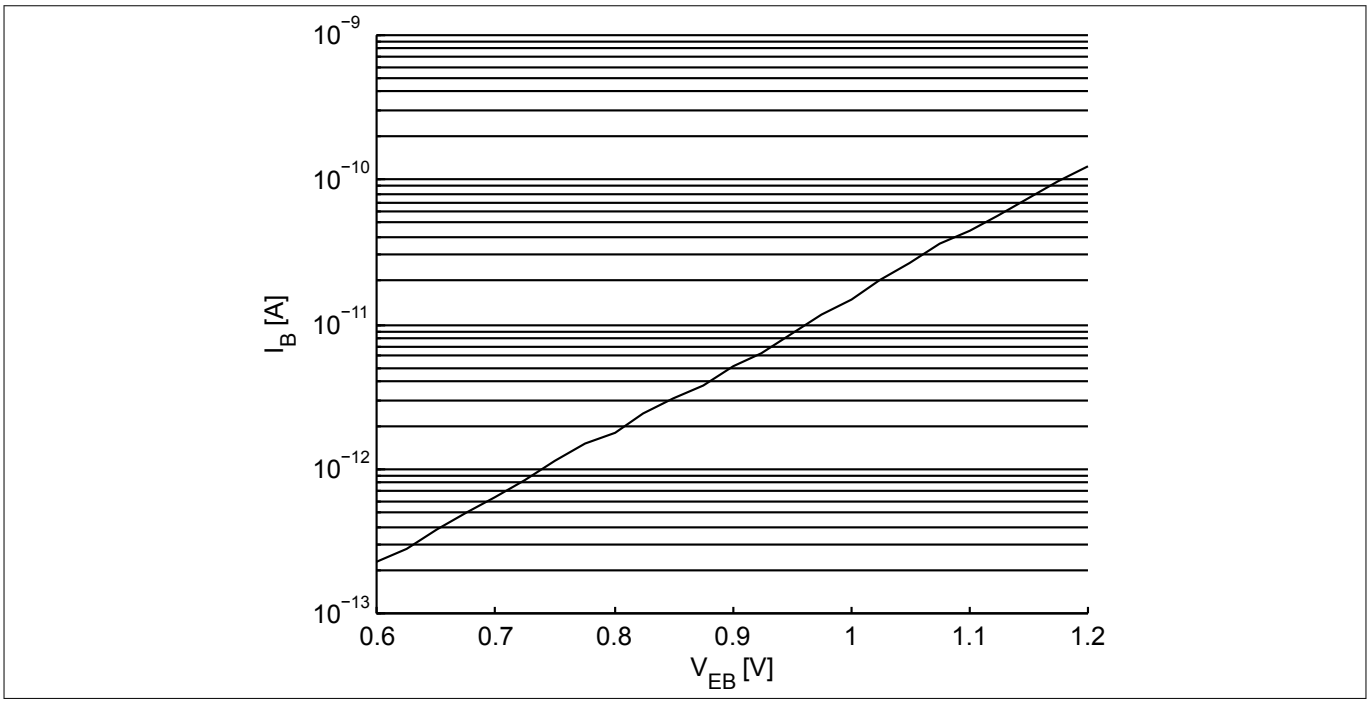


Figure 7 **Base current vs. base emitter reverse voltage $I_B = f(V_{EB})$, $V_{CE} = 2$ V**

3.5 Characteristic AC diagrams

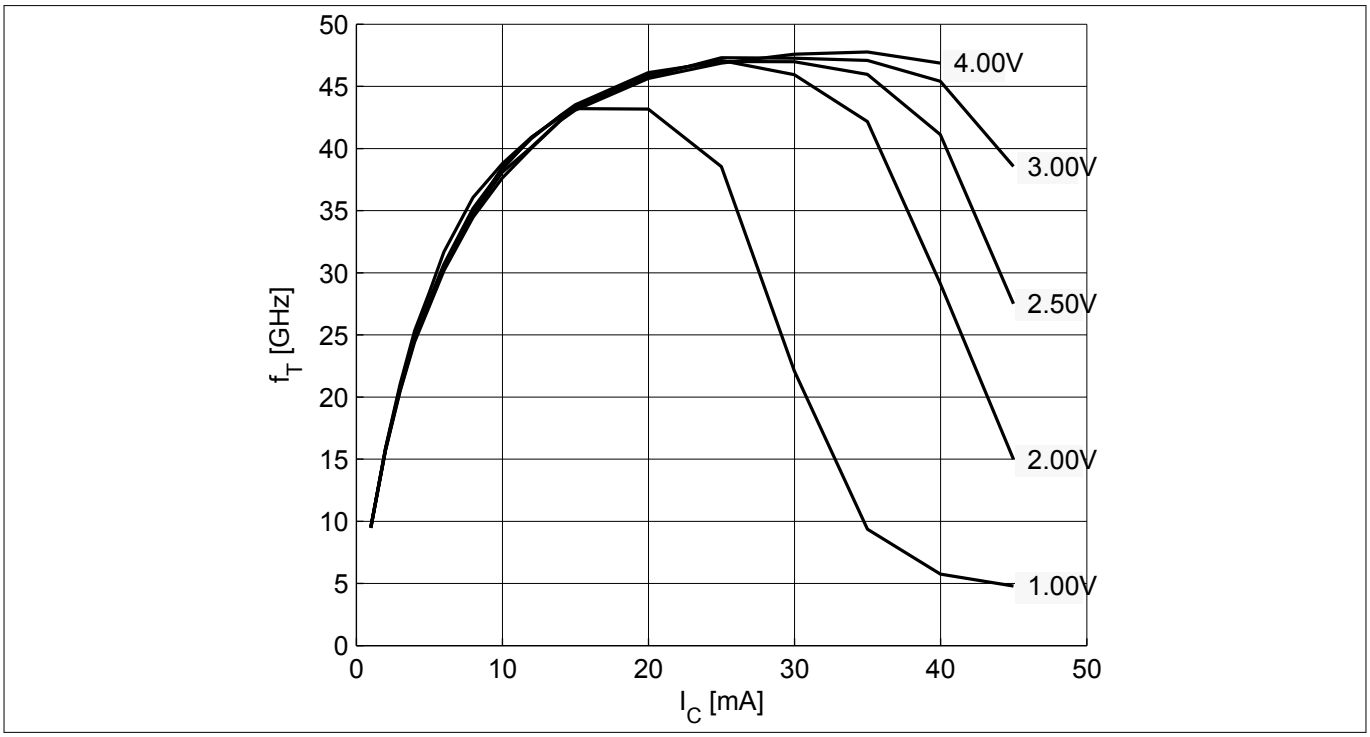


Figure 8 **Transition frequency $f_T = f(I_C)$, $f = 2$ GHz, V_{CE} = parameter**

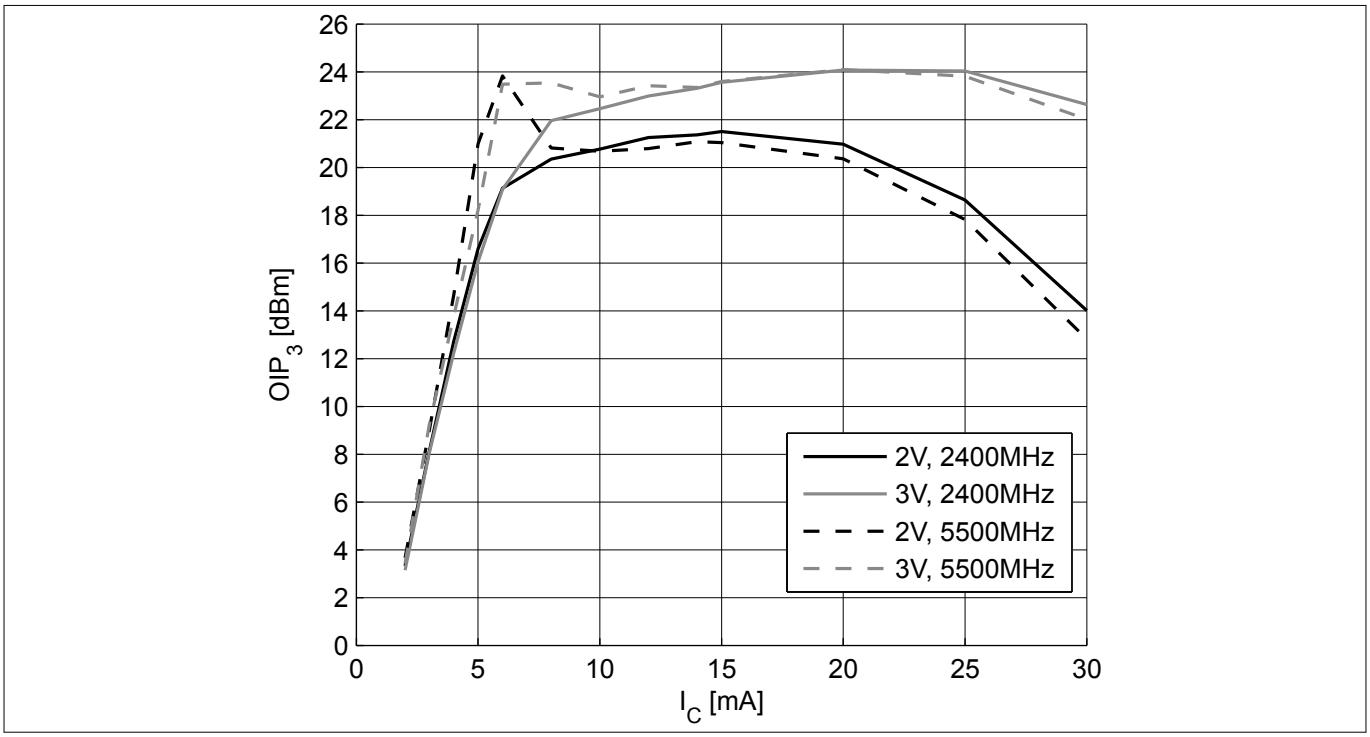


Figure 9 **3rd order intercept point $OIP_3 = f(I_C)$, $Z_S = Z_L = 50\ \Omega$, V_{CE}, f = parameters**

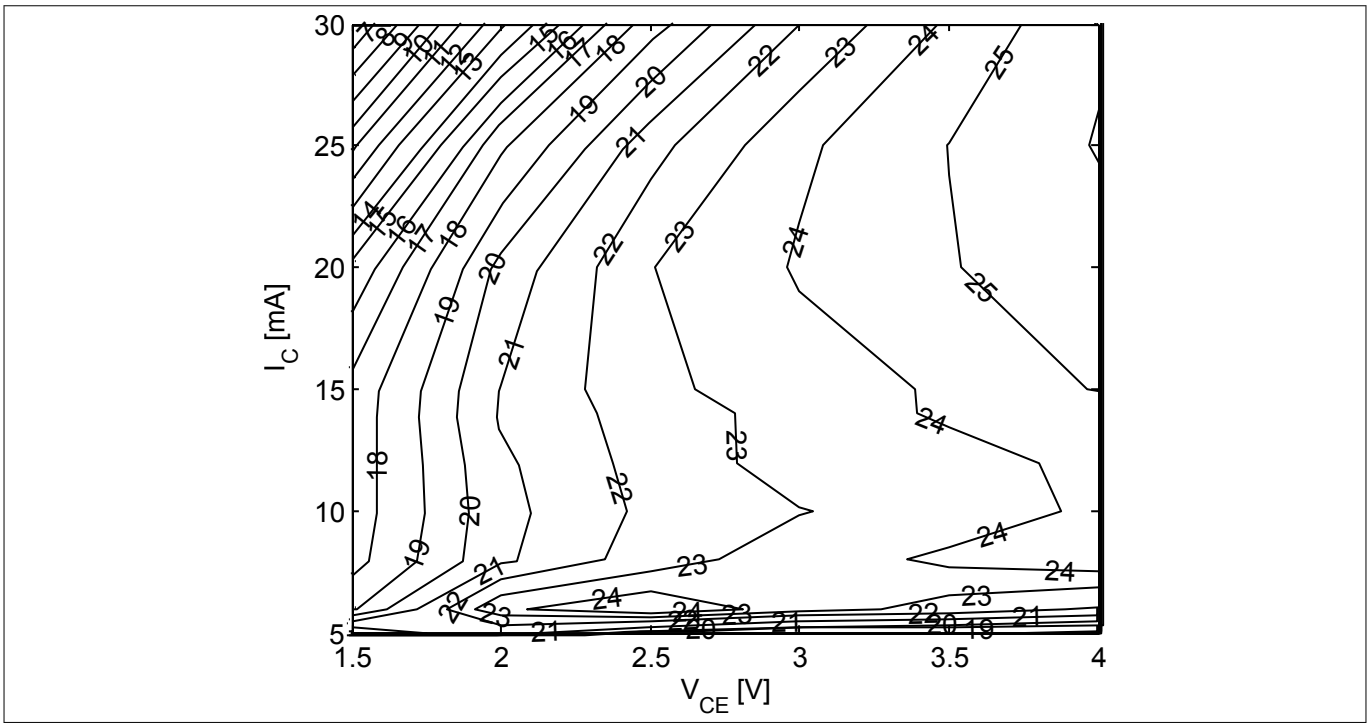


Figure 10 **3rd order intercept point at output OIP_3 [dBm] = f(I_C, V_{CE}), Z_S = Z_L= 50 Ω, f = 5.5 GHz**

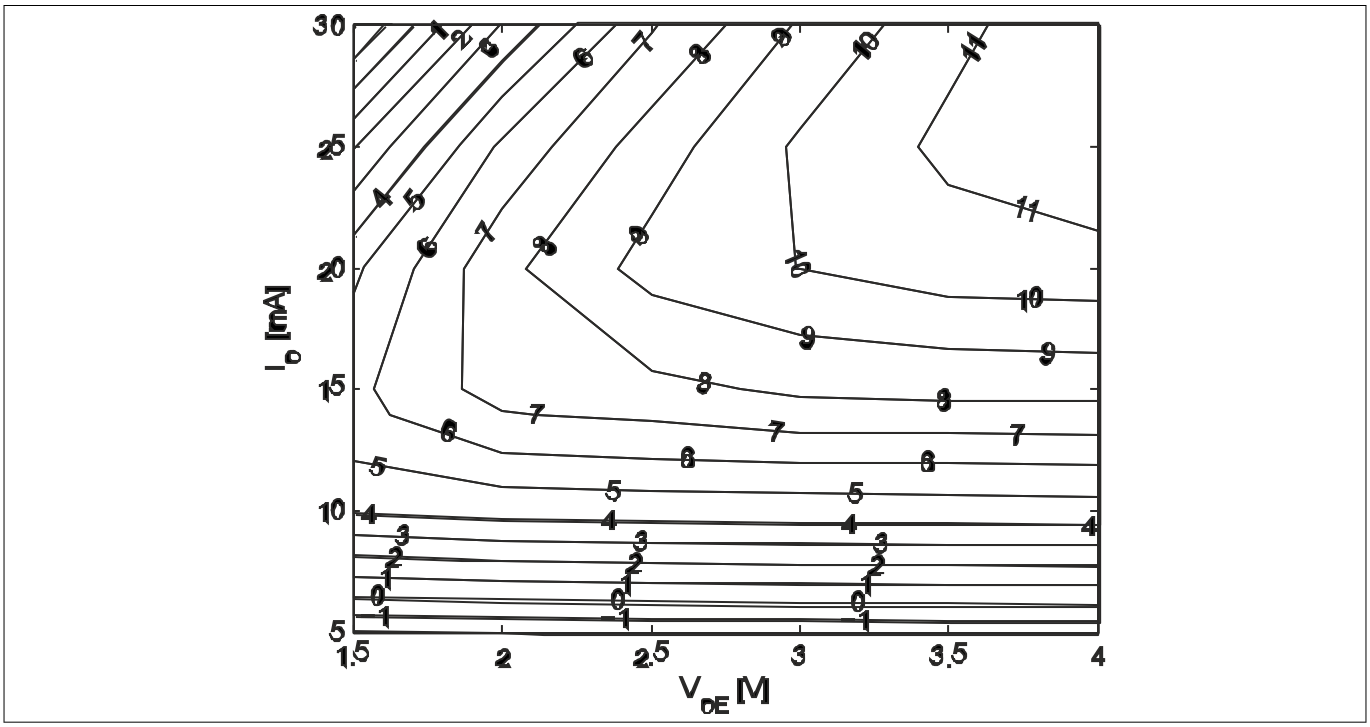


Figure 11 **Compression point at output OP_{1dB} [dBm] = f(I_C, V_{CE}), Z_S = Z_L= 50 Ω, f = 5.5 GHz**

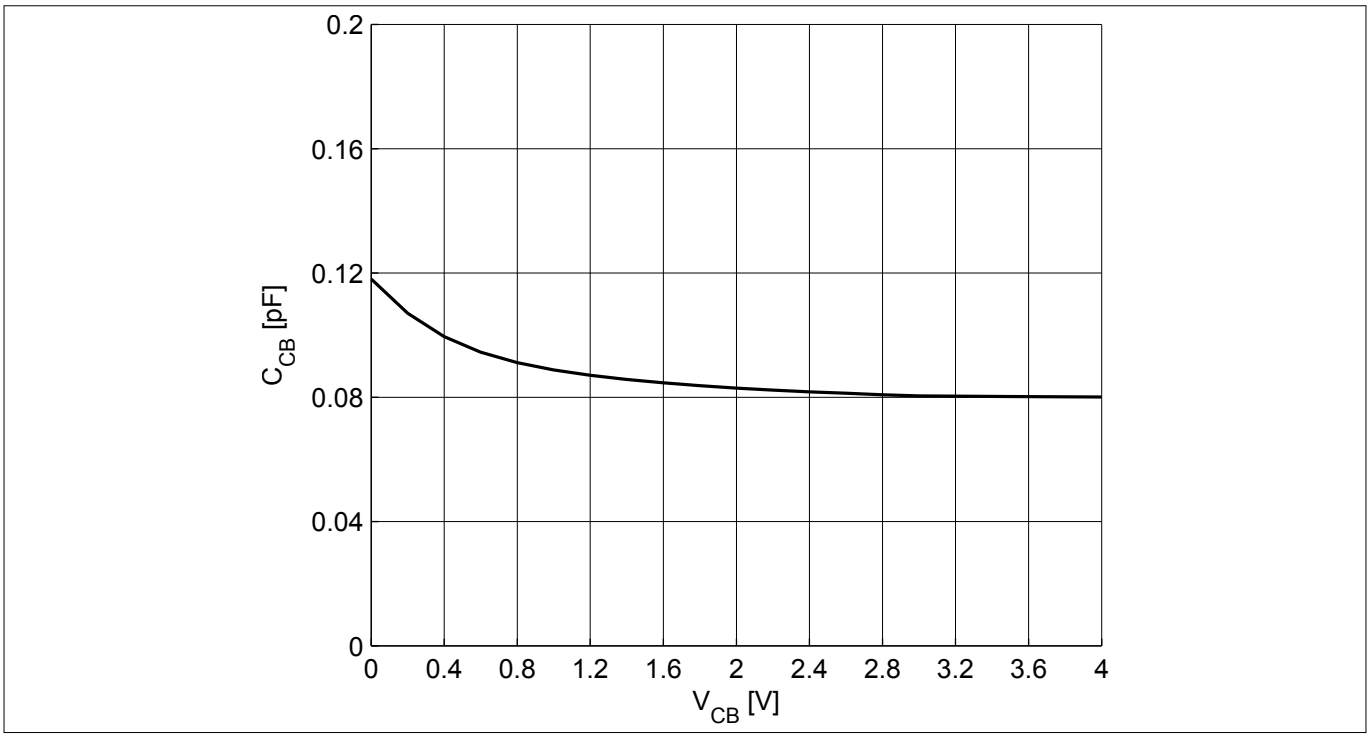


Figure 12 **Collector base capacitance $C_{CB} = f(V_{CB})$, $f = 1$ MHz**

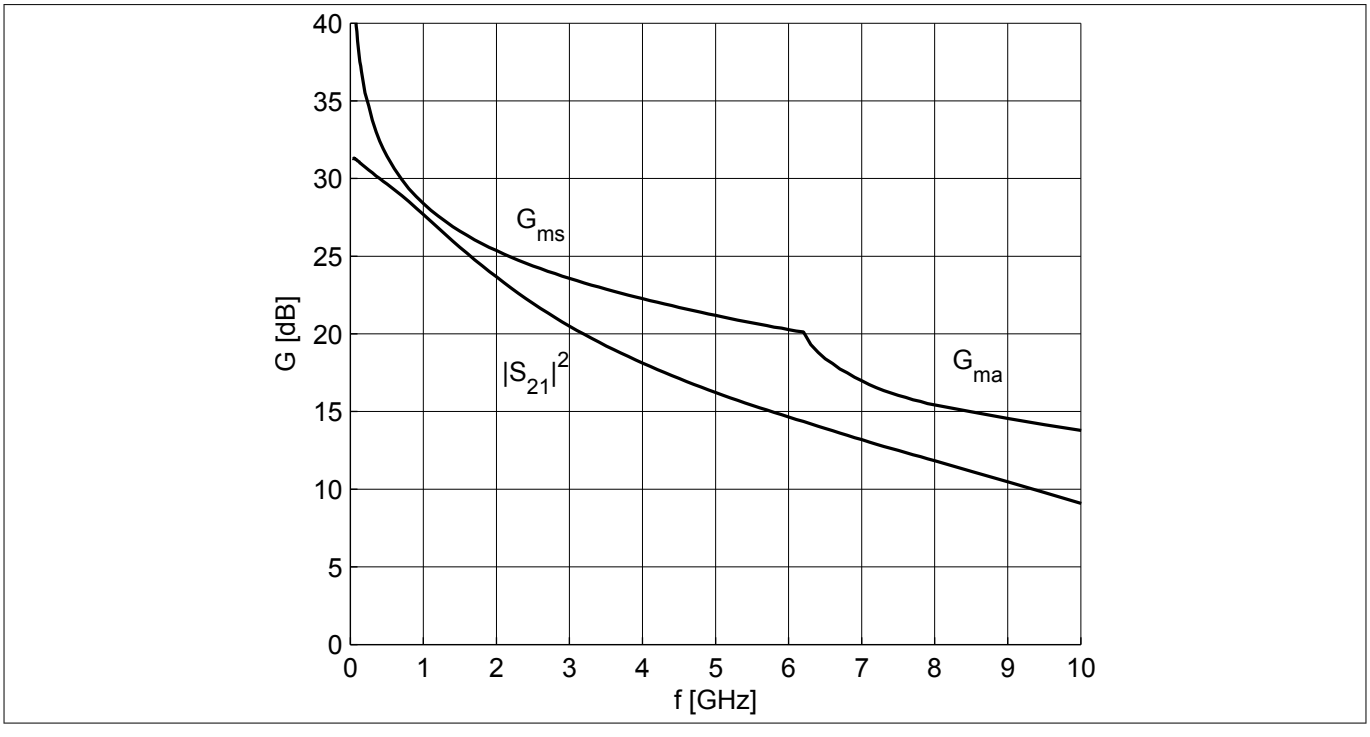


Figure 13 **Gain G_{ma}, G_{ms}, $|S_{21}|^2 = f(f)$, $V_{CE} = 3$ V, $I_C = 15$ mA**

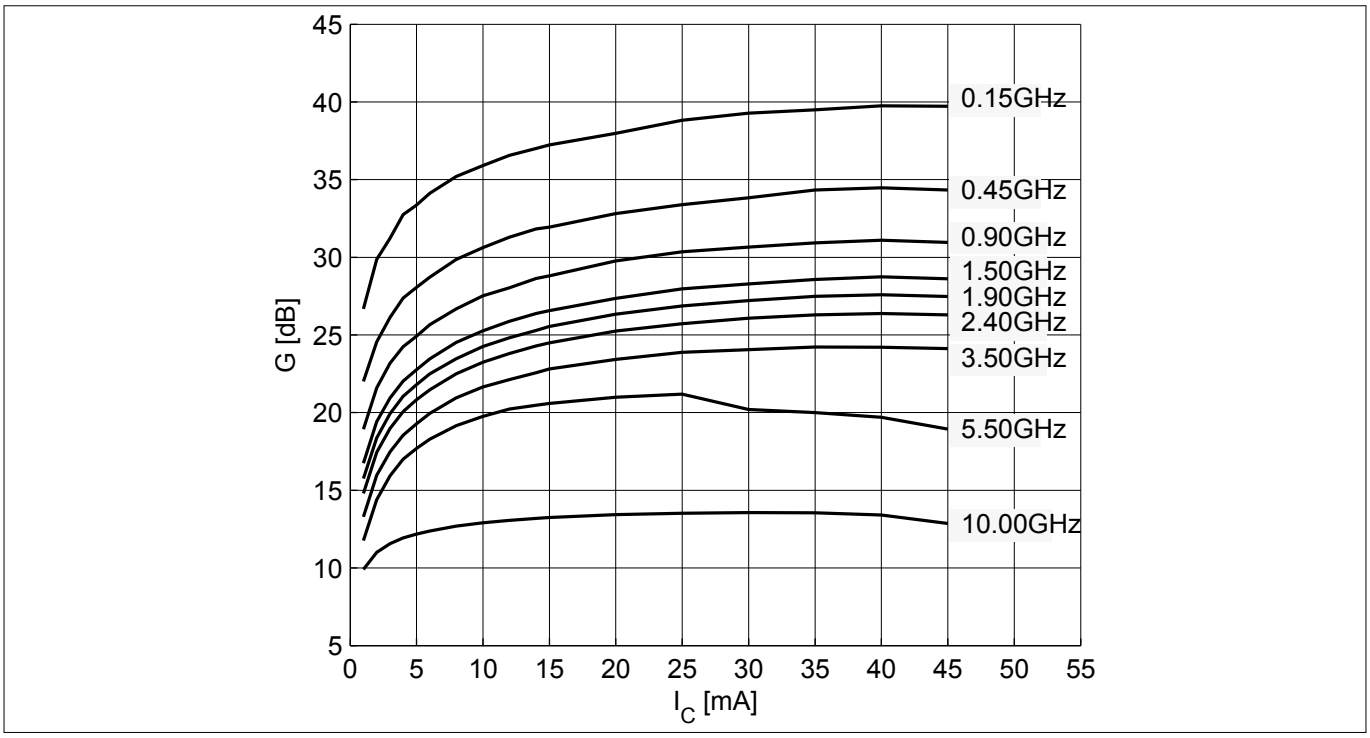


Figure 14 **Maximum power gain G_{max} = f(I_C), V_{CE} = 3 V, f = parameter in GHz**

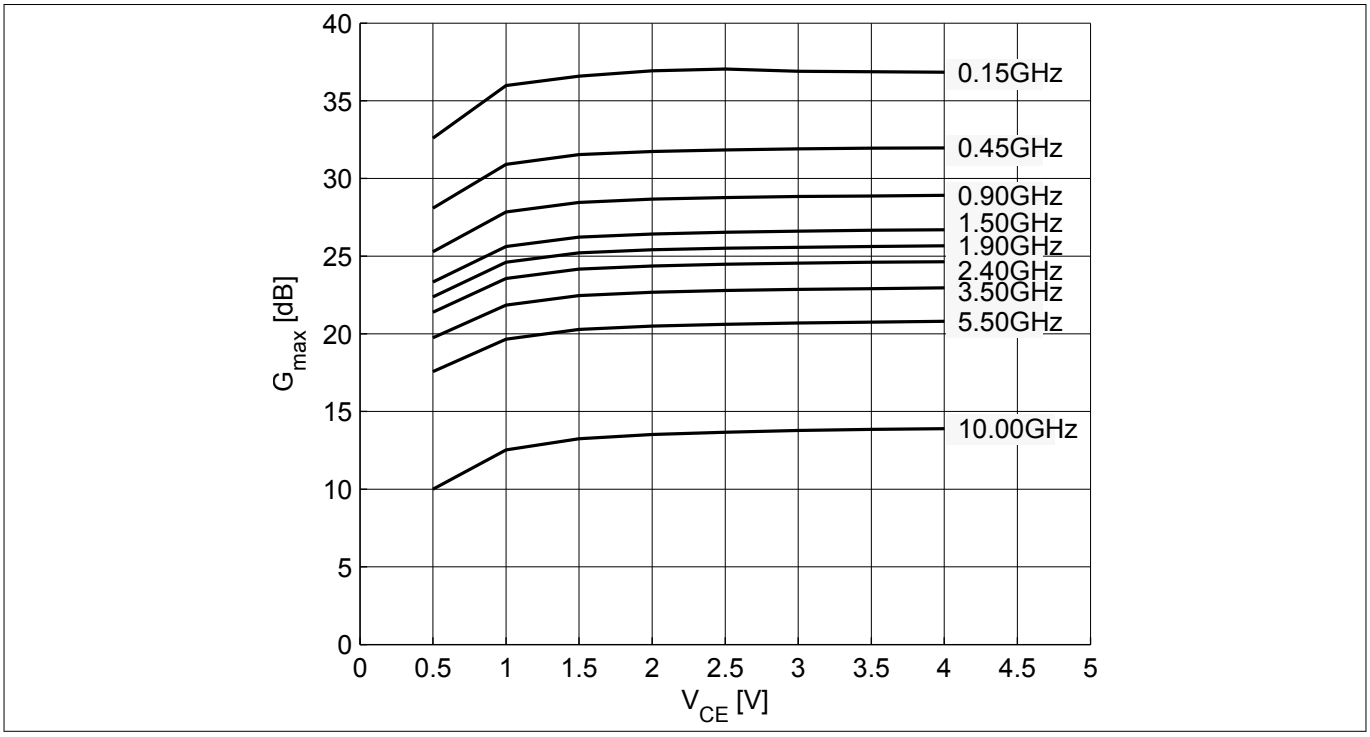


Figure 15 **Maximum power gain G_{max} = f(V_{CE}), I_C = 15 mA, f = parameter in GHz**

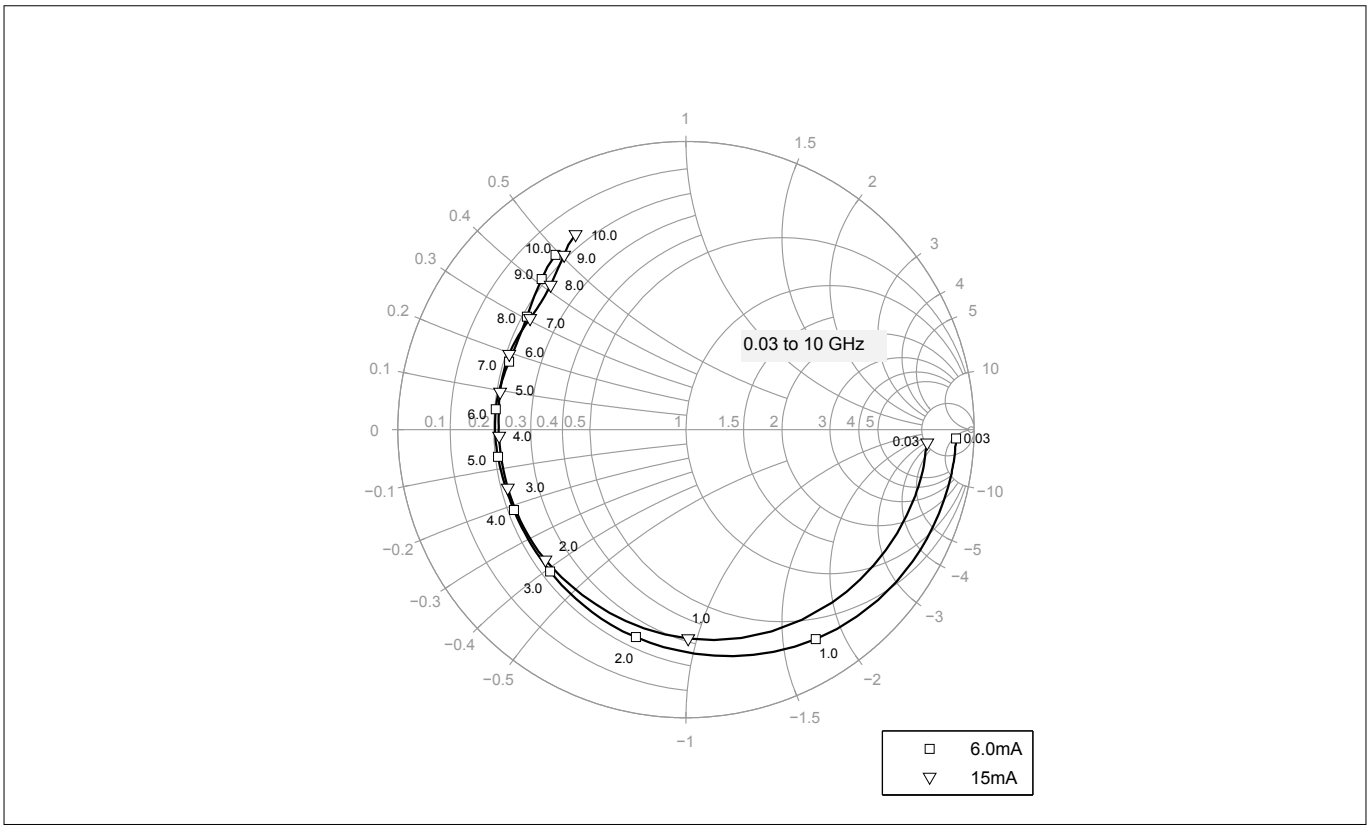


Figure 16 **Input reflection coefficient S_{11} = f(f), V_{CE} = 3 V, I_C = 6 / 15 mA**

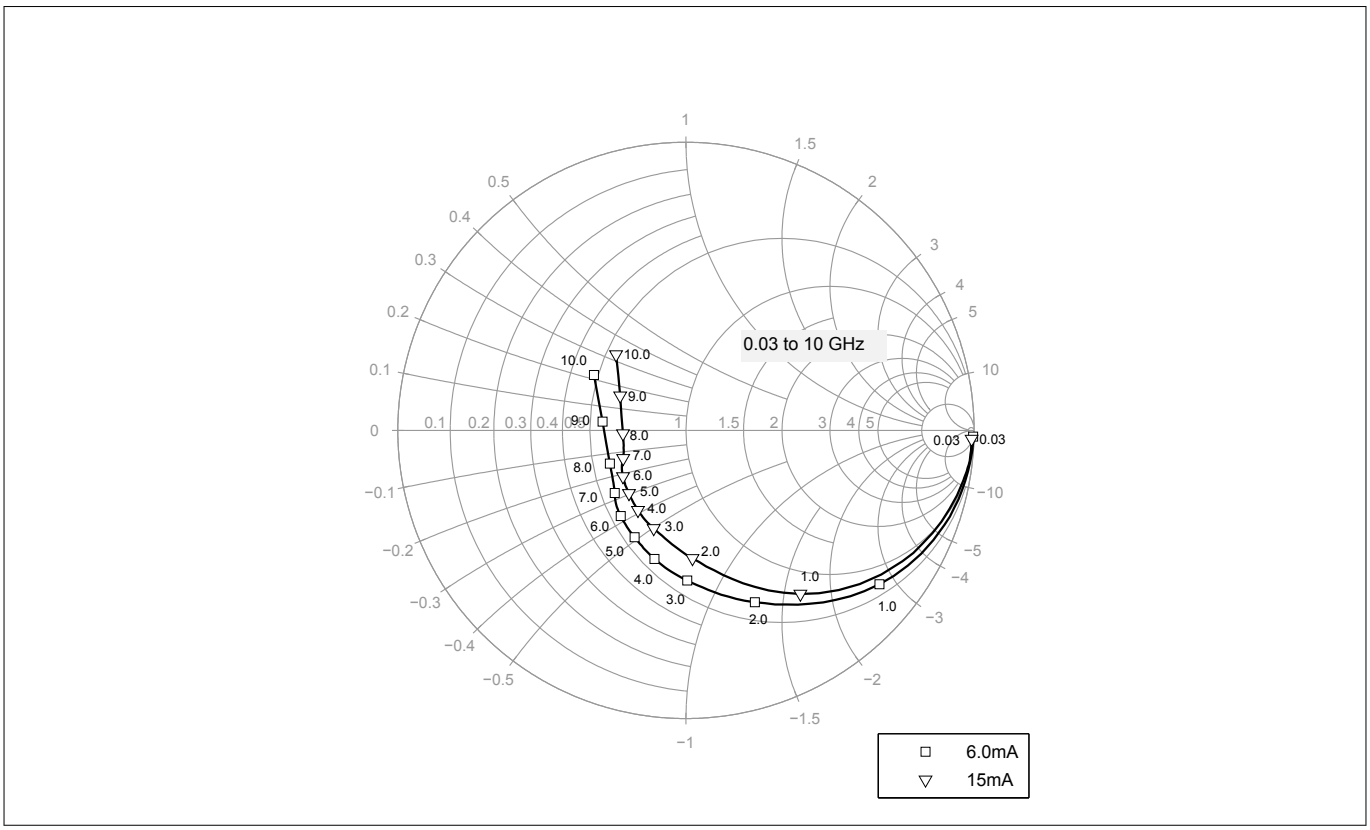


Figure 17 **Output reflection coefficient S_{22} = f(f), V_{CE} = 3 V, I_C = 6 / 15 mA**

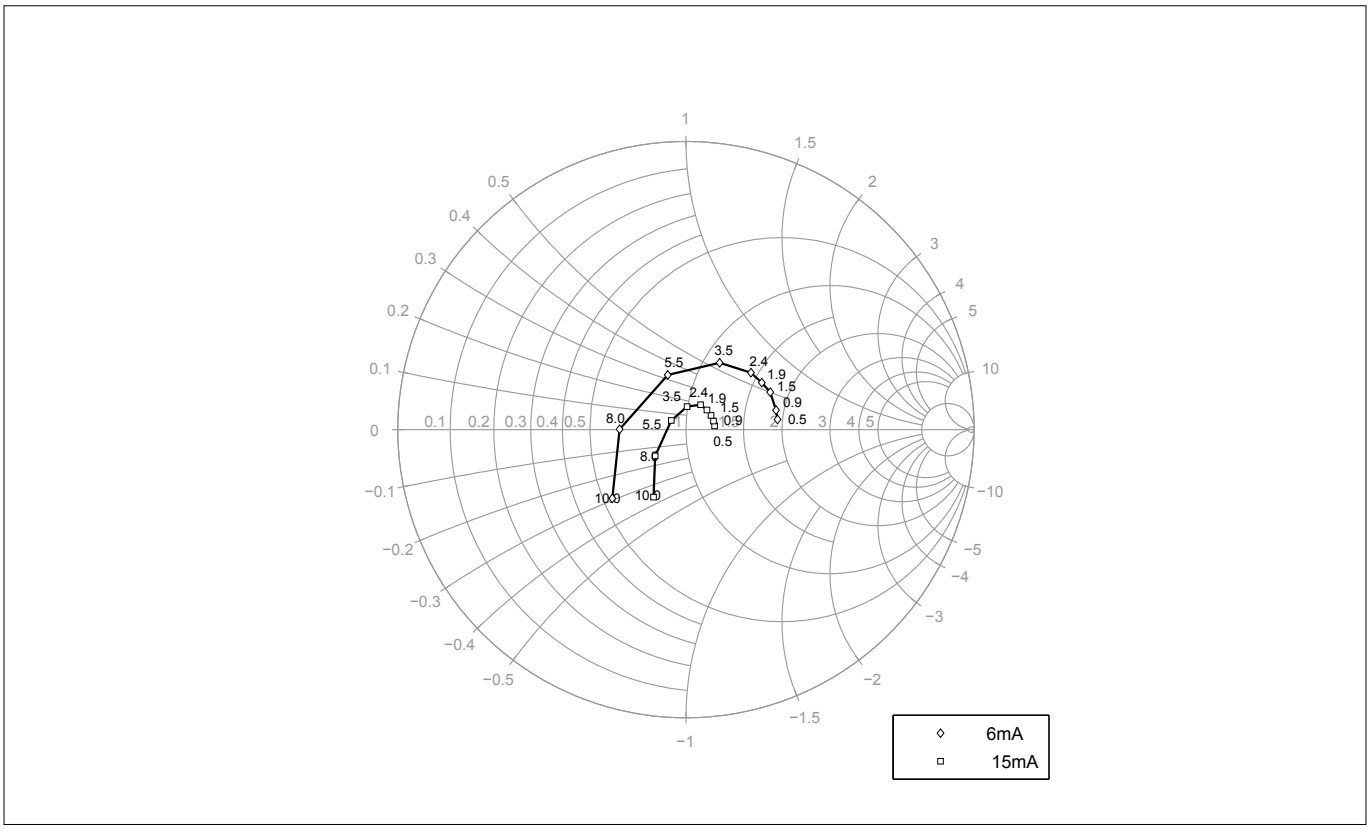


Figure 18 **Source impedance for minimum noise figure $Z_{S,opt}$ = f(f), V_{CE} = 3 V, I_C = 6 / 15 mA**

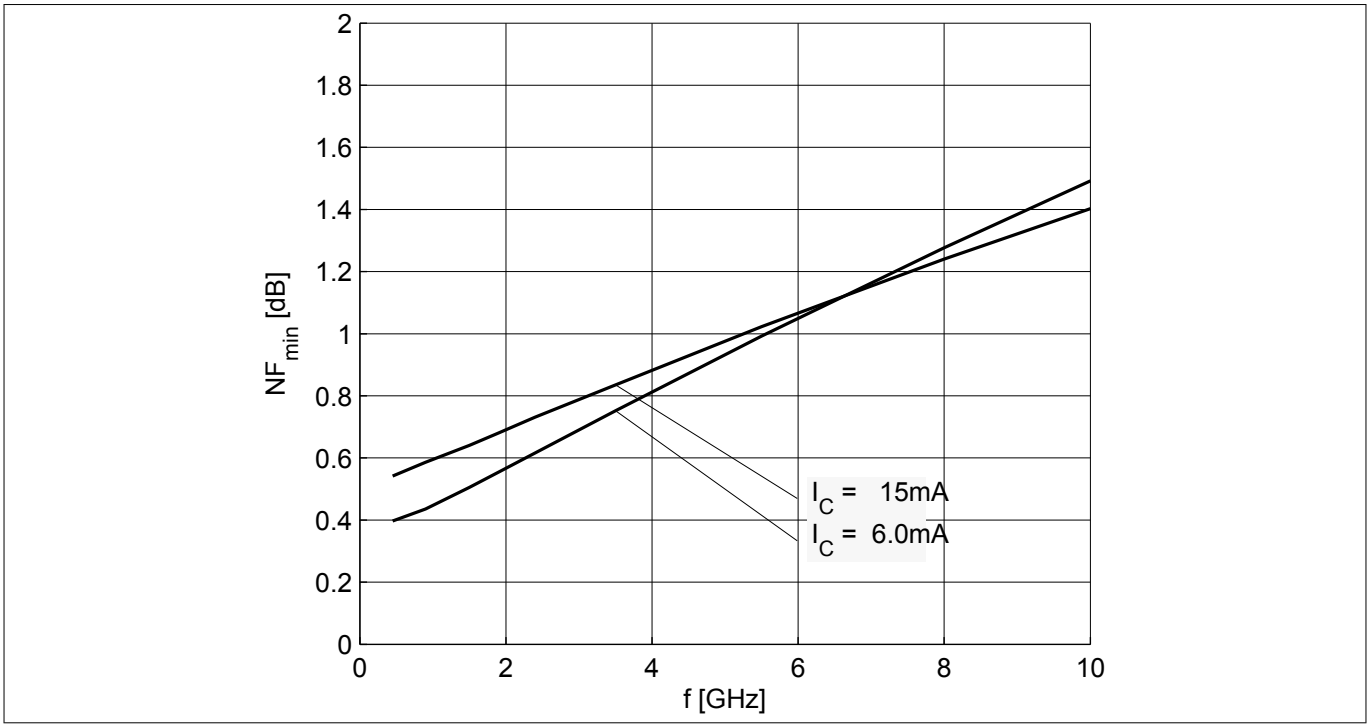


Figure 19 **Noise figure NF_{min} = f(f),V_{CE} = 3 V, Z_S = $Z_{S,opt}$, I_C = 6 / 15 mA**

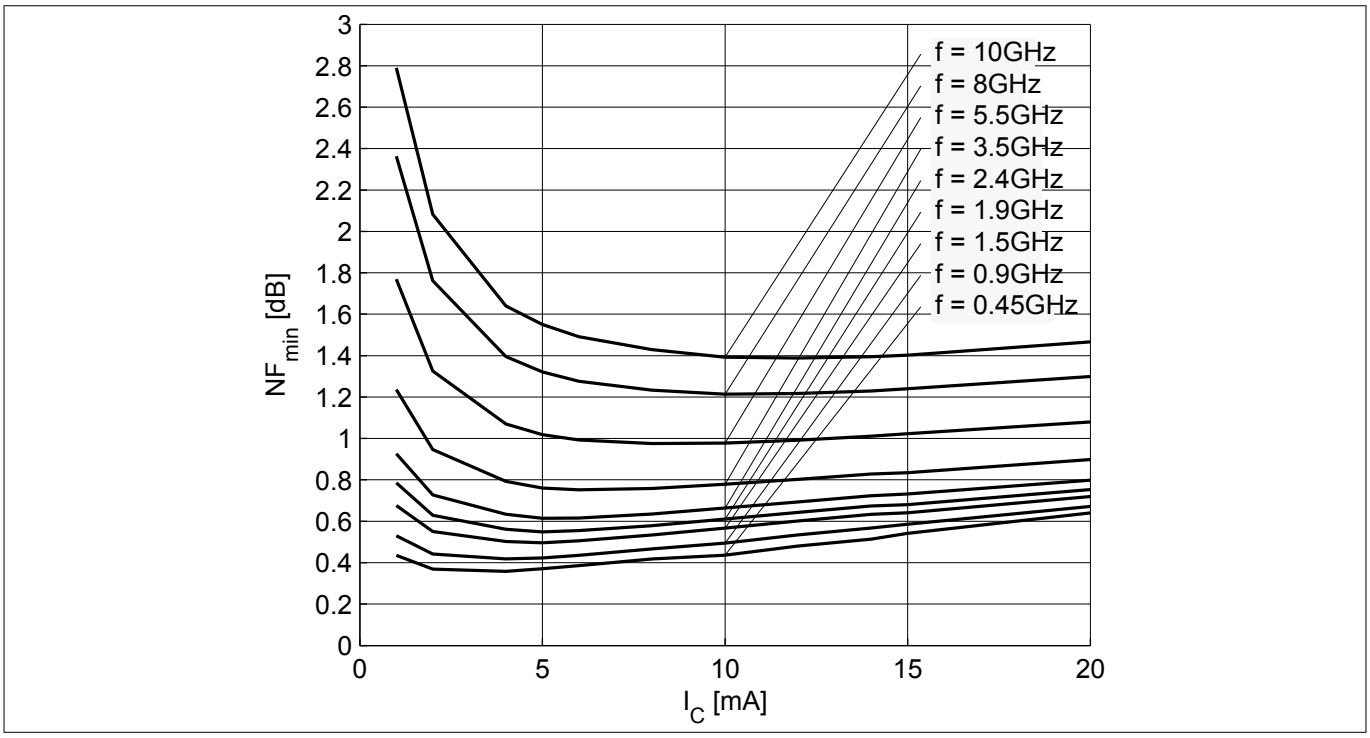


Figure 20 **Noise figure NF_{min} = f(I_C), V_{CE} = 3 V, Z_S = $Z_{S,opt}$, f = parameter in GHz**

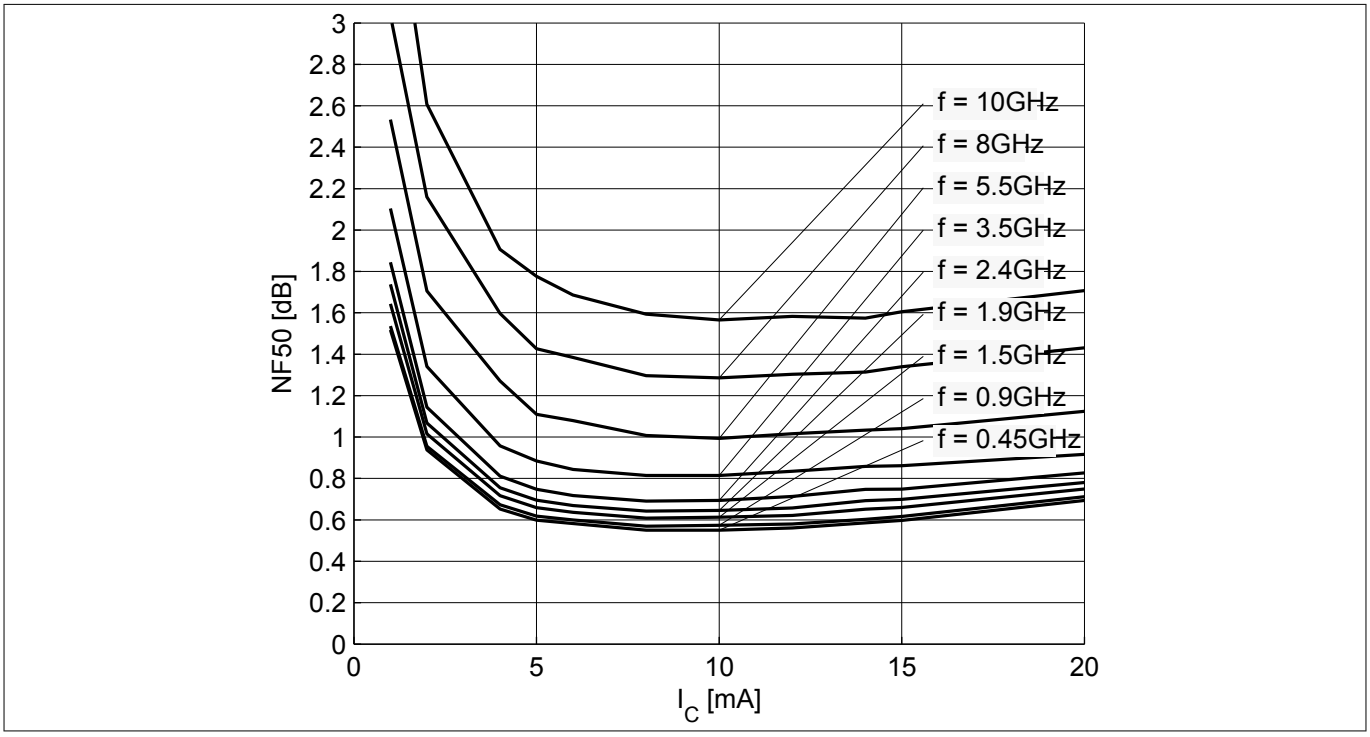


Figure 21 **Noise figure NF_{50} = f(I_C), V_{CE} = 3 V, Z_S = 50 Ω, f = parameter in GHz**

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. T_A = 25 °C.

4 Package information TSFP-4-1

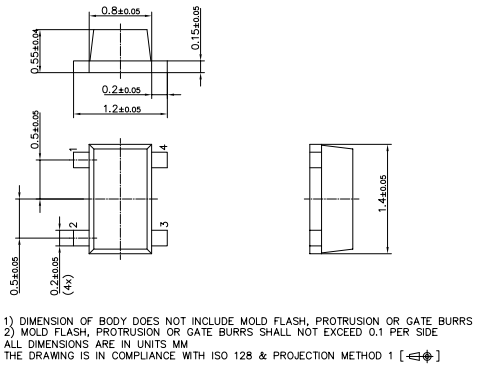


Figure 22 Package outline

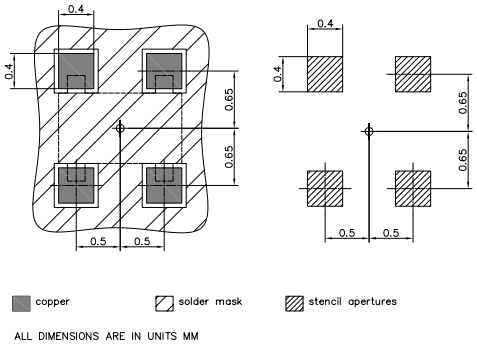


Figure 23 Foot print

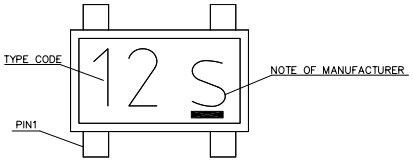


Figure 24 Marking layout example

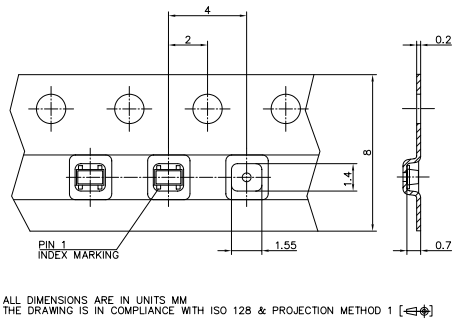


Figure 25 Tape dimensions

Revision history

Document version	Date of release	Description of changes
3.0	2018-09-26	New datasheet layout.

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